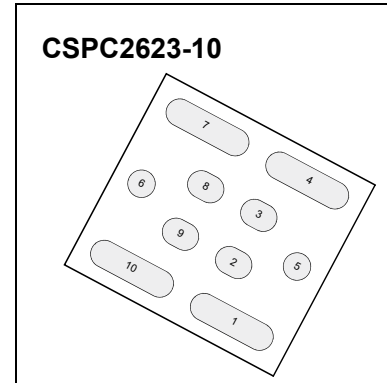




CSP Enhancement Mode Power MOSFET

CJ8209SP-A Dual N-Channel MOSFET

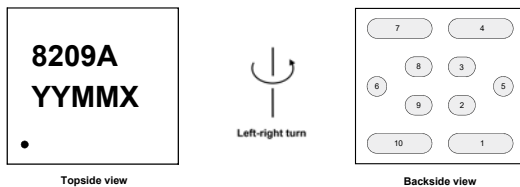
V _{SSS}	R _{SS(on)} TYP	I _S
12V	1.42mΩ@4.5V	17A
	1.52mΩ@3.8V	
	1.7mΩ@3.1V	
	2.0mΩ@2.5V	



DESCRIPTION

The CJ8209SP-A uses advanced trench technology to provide excellent R_{SS(ON)}, low gate charge and operation with gate voltages as low as 2.5V while retaining a 8V V_{GS(MAX)} rating. It is ESD protected. This device is suitable for use as a unidirectional or bi-directional load switch, facilitated by its common-drain configuration.

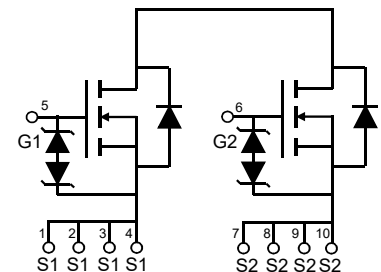
Marking and pin assignment



Marking:

1. 8209A: Product Code	1, 2, 3, 4	Source1
2. YYMMX: Date Code	7, 8, 9, 10	Source2
3. Solid dot: Pin 1	5	Gate1
	6	Gate2

Equivalent Circuit



ABSOLUTE MAXIMUM RATINGS (T_a=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Source to Source Voltage	V _{SSS}	12	V
Gate-Source Voltage	V _{GSS}	±8	V
Source Current(DC)	I _S ^①	17	A
Source Current (Pulsed)	I _{SP} ^①	170	A
Total Power Dissipation	P _T ^①	1.56	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature Range	T _{STG}	-55 To 150	°C

MOSFET ELECTRICAL CHARACTERISTICS

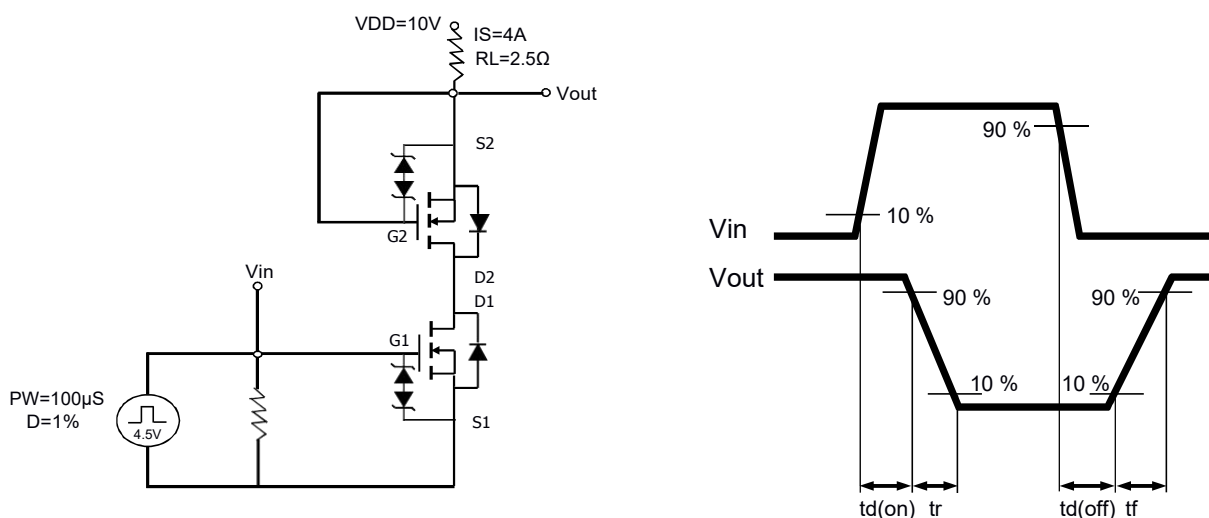
$T_a=25\text{ }^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static Parameters						
Source to Source Breakdown Voltage	BV_{SSS}	$I_S=1\text{mA}, V_{GS}=0\text{V}$	12			V
Zero-Gate Voltage Source Current	I_{SSS}	$V_{SS}=10\text{V}, V_{GS}=0\text{V}$			100	nA
Gate to Source Leakage Current	I_{GSS}	$V_{SS}=0\text{V}, V_{GS}=\pm 8\text{V}$			± 10	μA
Gate to Source Threshold Voltage	$V_{GS(th)}$	$V_{SS}=V_{GS}, I_S=1.04\text{ mA}$	0.4	0.8	1.4	V
Source to Source On-state Resistance	$R_{SS(on)}$	$V_{GS}=4.5\text{V}, I_S=3\text{A}$	0.8	1.42	1.9	$\text{m}\Omega$
		$V_{GS}=3.8\text{V}, I_S=3\text{A}$	0.9	1.52	2.0	$\text{m}\Omega$
		$V_{GS}=3.1\text{V}, I_S=3\text{A}$	1.0	1.7	2.8	$\text{m}\Omega$
		$V_{GS}=2.5\text{V}, I_S=3\text{A}$	1.25	2.0	4.5	$\text{m}\Omega$
Input Capacitance	C_{iss}	$V_{SS}=10\text{V}, V_{GS}=0\text{V}, f=1\text{kHz}$		4596		pF
Output Capacitance	C_{oss}			891		pF
Reverse Transfer Capacitance	C_{rss}			734		pF
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10\text{V}, I_S=4\text{A}, V_{GS}=4.5\text{V}$		1.24		μs
Turn-on Rise Time	t_r			4.36		μs
Turn-off Delay Time	$t_{d(off)}$			9.3		μs
Turn-off Fall Time	t_f			9.5		μs
Total Gate Charge	Q_g	$V_{SS}=10\text{V}, I_S=10\text{A}, V_{GS}=4.5\text{V}$		61.5		nC
Gate1-source1 charge	Q_{g1s1}			5.4		nC
Gate1-source2 charge	Q_{g1s2}			24		nC
Diode Forward Voltage	$V_{F(S-S)}$	$V_{GS}=0\text{V}, I_S=10\text{A}$			1.0	V

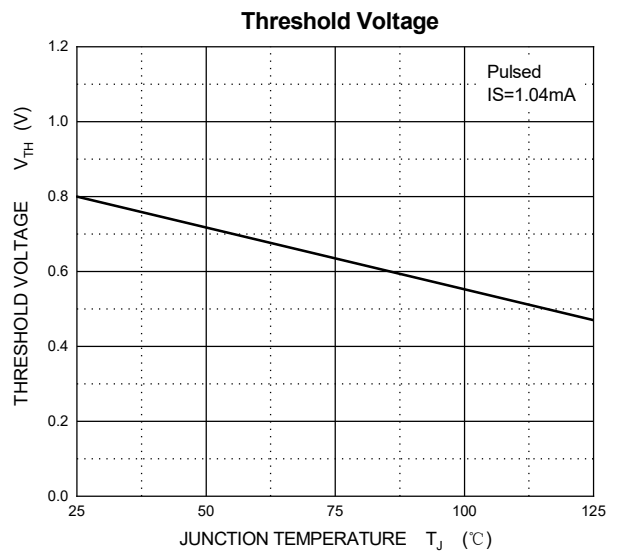
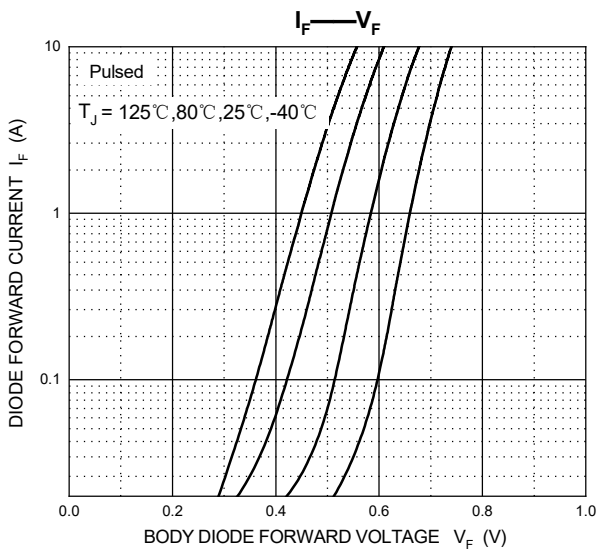
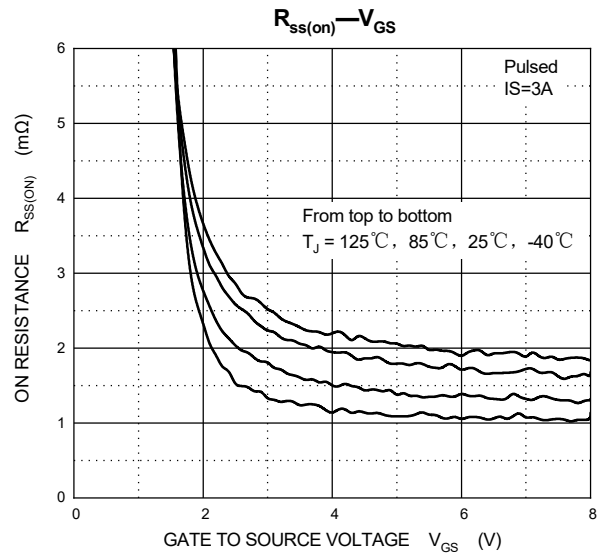
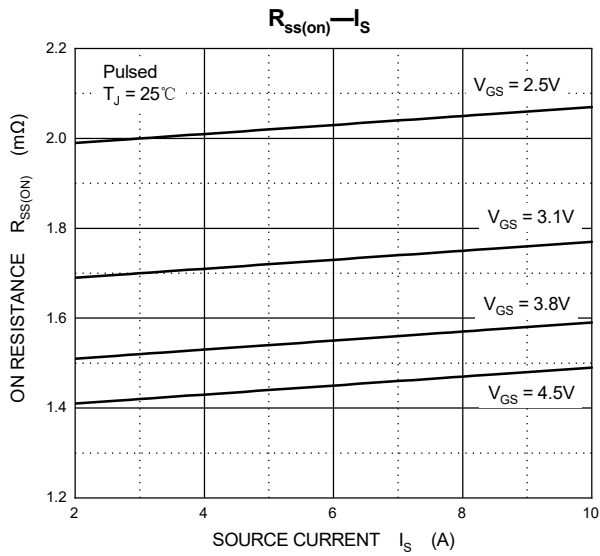
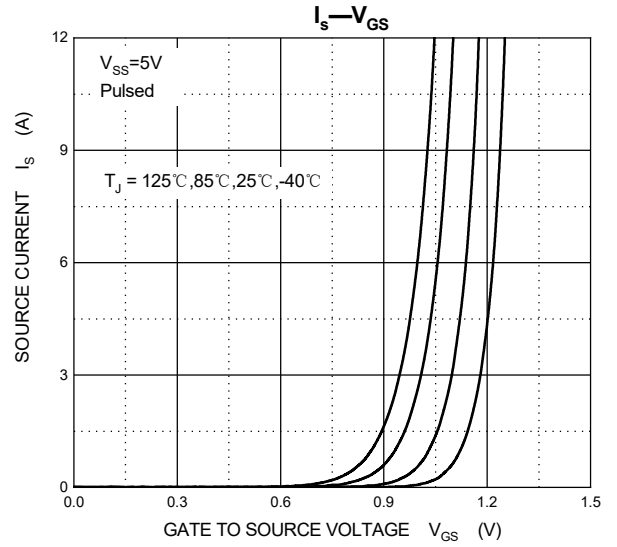
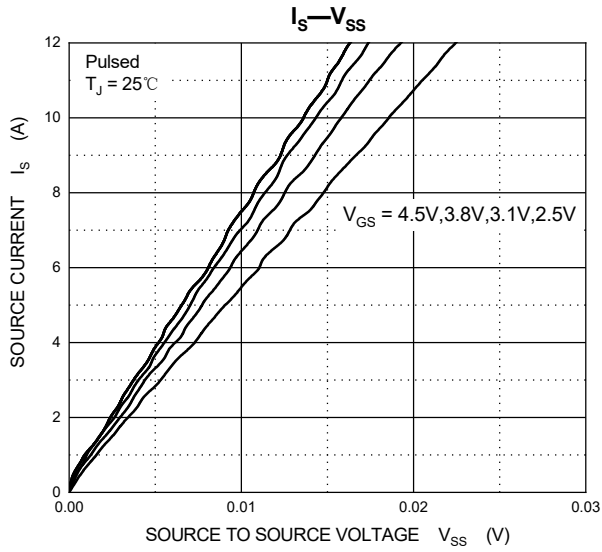
Notes: 1. Mounted on FR4 board (25.4mm×25.4mm×1.0mm) using the minimum recommended pad size (36um Copper).

2. $t = 10\text{ ms}$, Duty Cycle = 1%.

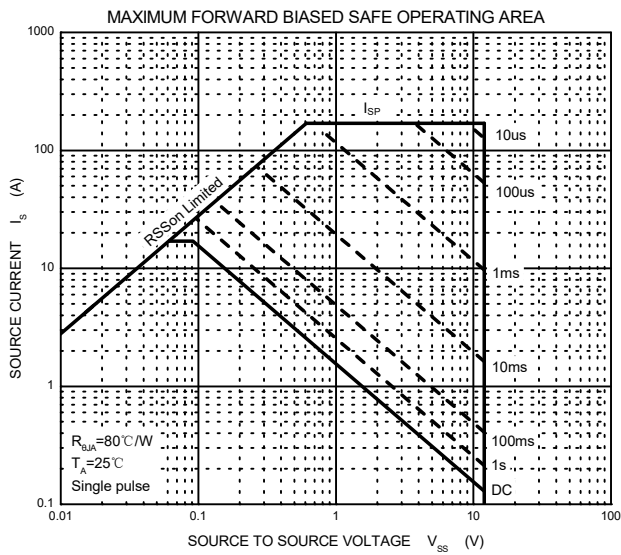
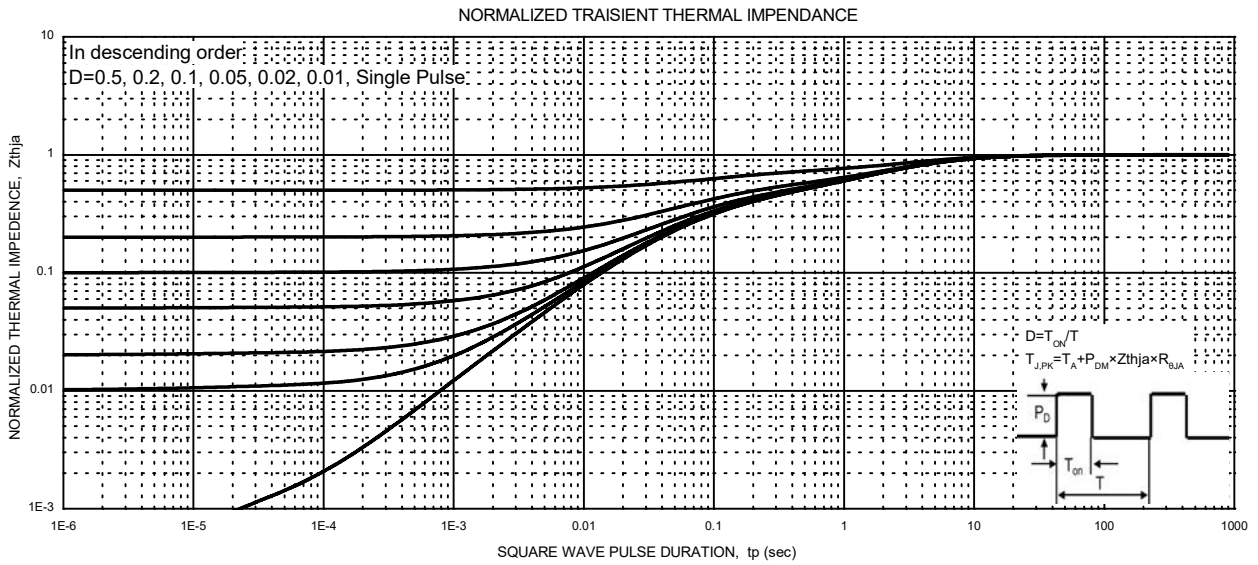
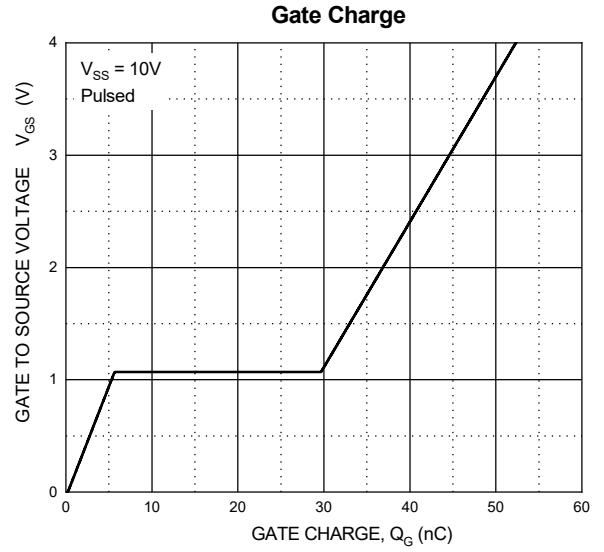
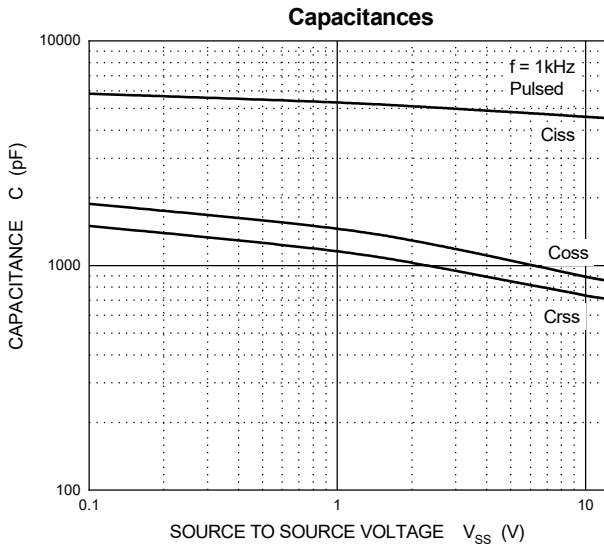
3. When FET1 is measured, G2 and S2 are short-circuited.



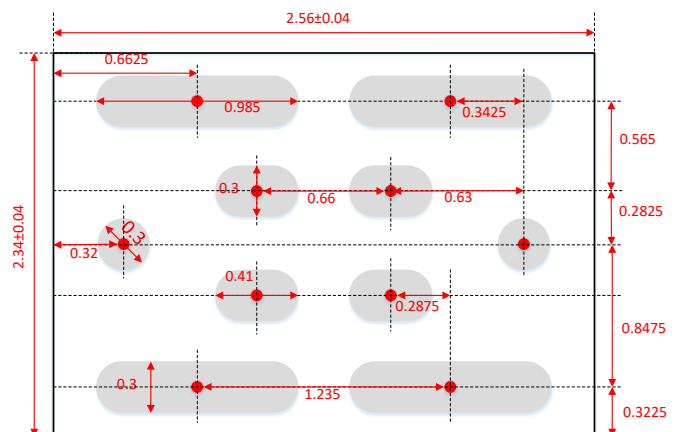
Typical Characteristics



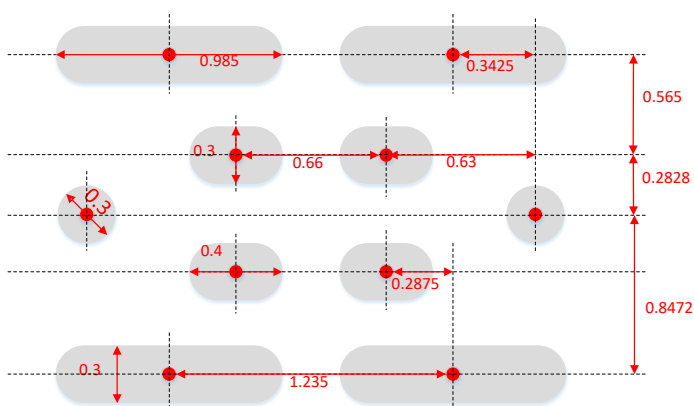
Typical Characteristics



CSPC2623-10 Package Outline Dimensions(Unit:mm)



CSPC2623-10 Suggested Pad Layout (Unit:mm)



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.050 mm.
3. The pad layout is for reference purposes only.

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